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3. Nature of conveyance/Execution Date(s):	Street Address: P. O. Box 9005	
Execution Date(s) 08/04/04;08/11/04;08/11/04	One Corporate Center CT10C	
Assignment Merger		
Security Agreement Change of Name	City: Kokomo	
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4. Application or patent number(s):  This document is being filed together with a new application.  A. Patent Application No.(s)  B. Patent No.(s)		
10/708,936	B. Patent No.(s)	
Additional numbers attached? Yes No		
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: <u>Hartman &amp; Hartman</u>		
Internal Address:	7. Total fee (37 CFR 1.21(h) & 3.41) \$	
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**PATENT** 

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REEL: 017003 FRAME: 0754

DP-309106

## **ASSIGNMENT**

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application US Serial No. 10/708,936, filed 04/01/04, entitled

## **ENCAPSULATION WAFER PROCESS**

for which I executed a declaration dated as indicated below.

Inventor's signature	Inga Cham	Date 8-4-04
Full Name:	TROY A. CHASE	Declaration dated:
Residence:	KOKOMO, INDIANA	8-4-04
Inventor's signature	James H. Fogsdon	Date 8-//-04
Full Name:	ZAMES H. LOGSDON	Declaration dated:
Residence:	KOKOMO, INDIANA	8-11-04
Inventor's signature	Janea E Krym	Date 08-11-04
Full Name:	JAMES E. KINGERY	Declaration dated:
Residence:	LOGANSPORT, INDIANA	08-11-04

**PATENT REEL: 017003 FRAME: 0755** 

**RECORDED: 11/10/2005**